



Cypress Semiconductor Corporation – An Infineon Technologies Company
198 Champion Court, San Jose, CA 95134. Tel: (408) 943-2600

PRODUCT CHANGE NOTIFICATION

PCN: PCN201502A

Date: April 24, 2020

Subject: Addendum to PCN201502 - Qualification of Fab 25 as an Alternate Wafer Fab Site and a Bond Wire Change for Industrial-Grade 4Kb, 16Kb and 64Kb F-RAM Products

To: TOKYO ELECTRON DEVICE
TELDEVICE
cy-inside@teldevice.co.jp

Change Type: Major

Description of Change:

The purpose of this addendum is to update the affected parts list and to attached QTP194521 package qualification report missed in the initial PCN201502. Refer to the “Remark” in the affected parts list.

Cypress announced the qualification of Fab 25 (5204 East Ben White Boulevard, Austin, TX78741, USA) as an alternate wafer fab site for industrial-grade 4Kb, 16Kb and 64Kb F-RAM products. The new industrial-grade 4Kb, 16Kb and 64Kb F-RAM products are form, fit and function compatible with the current industrial-grade 4Kb, 16Kb and 64Kb F-RAM products manufactured at Global Foundries. Additionally, for products in the DFN package, the wire material is changed from Au to CuPdAu. There will be no change to the existing marketing part numbers.

Benefit of Change:

Qualification of alternate manufacturing sites and technologies is part of Cypress’ ongoing flexible manufacturing initiative. The goal of the flexible manufacturing initiative is to provide the means for Cypress to continue to meet delivery commitments through dynamic, changing market conditions.

Part Numbers Affected: 34

See the attached ‘Affected Parts List’ file for a list of all part numbers affected by this change. Note that any new parts that are introduced after the publication of this PCN will include all changes outlined in this

Qualification Status:

This wafer fab site has been qualified through a series of tests documented in the Qualification Test Plan QTP#192810 and QTP#194521. These qualification reports can be found as attachments to this PCN or by visiting www.cypress.com and typing the QTP number in the keyword search window.

Sample Status:

Please review the attached 'Affected Parts List' file for a list of affected part numbers with their associated Wafer Fab site sample ordering part numbers. Samples are available now unless there is an indication that the sample ordering part numbers are subject to lead times. If you require qualification samples, please contact your local Cypress sales representative as soon as possible, preferably within 30 days of the date of this PCN, to place any sample orders.

Approximate Implementation Date:

Effective 90 days from the date of this notification or upon customer approval, whichever comes first, all shipments Industrial part numbers in the attached file will be supplied from Fab25 or other approved wafer fabrication sites.

Anticipated Impact:

Products fabricated at the new site are completely compatible with existing products from form, fit, functional, parametric and quality performance perspectives.

Cypress also recommends that customers take this opportunity to review these changes against current application notes, system design considerations and customer environment conditions to assess impact (if any) to their application.

Method of Identification:

Cypress maintains traceability of product to wafer level, including wafer fabrication location, through the lot number marked on the package.

Response Required:

No response is required.

For additional information regarding this change, contact your local sales representative or contact the PCN Administrator at pcn_adm@cypress.com.

Sincerely,

Cypress PCN Administration